Update analysis of TPC detector prototype using UV laser tracks

Huirong Qi ZhiYang Yuan, Yue Chang, Liwen Yu, Wei Liu, Jian Zhang, Hongliang Dai, Zhi Deng, Yulan Li, Hui Gong

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TPC detector with UV laser

2 dE/dx resolution

3 New electronic testing

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Motivation-spatial resolution



$$\sigma_{dE/dx} = \sigma_0 N_{hits}^{-k}$$

Experiment	Readout	Points	Sample	p(GeV/c)	$(\sigma_l/I)_{MC}$	$(\sigma_l/I)_{exp}$
	Pad (<i>mm</i>)					
PEP-4 TPC	4	183	е	14.5	2.6%	3.5%
TOPAZ TPC	4	175	π	0.4-0.6	3.8%	4.5%
DELPHI TPC	4	192	π	0.4-0.6	5.4%	6.2%
ALEPH TPC	4	344	е	45.6	3.0%	4.4%
STAR TPC	12, 20	13,32	π	0.4-0.6	5.3%	6.8%
ALICE TPC	7.5, 10, 15	63,64,32	π	6.0	3.3%	5.0%
TPC for CEPC	1mm×6mm	220	K	5.0	3.1%	
	Pixel(µm)					
<u>GridPix</u> TPC for ILD	55×55	9500	е	2.5	/	4.1%

NO magnetic field NO high energy particle testing beam



3

TPC detector with UV laser



Detector and PCB readout board

TPC detector with UV laser



Diagram of TPC detector study

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⁵⁵Fe study



Energy spectrum and gain at T2K/P10/Ar:CO2

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UV laser spectrum - Truncated method



Energy cutting and correction by the events

Energy spectrum of UV

6

dE/dx resolution – 38 hit points



$$\sigma_{dE/dx} = (8.9 \pm 0.4) \,\%$$
(38hits)

9

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dE/dx resolution – along drift length



dE/dx resolution - pseudo-tracks using full size



dE/dx resolution - pseudo-tracks of the different hit points



dE/dx resolution – comparison of the existing prototypes



Low power ASIC chip



Layout of ASIC chip

puna habc, porate ared



Test of the signals

ASIC chip for TPC readout have been developed

- The power consumption is 2.33 <u>mW/channel</u>
 - \square P_{AFE} = 1.43 mW/channel
 - \square P_{ADC} = 0.9 mW/channel @ 40M/s
- ENC =852e @Cm = 2pF, gain =10 mV/fC and can be reduced to 474e using digital trapezoidal filter

Low power ASIC chip- ADC simulation



1 LSB=1600 mV/1024=1.56 mV

Low power ASIC chip- Integral Nonlinearity



16

Low power ASIC chip- WASA_V0 testing board



Channels: ≤ 128 channels (64 channels available) External power supply: $\pm 5V$, $\pm 12V$, $\pm 24V$

Low power ASIC chip- WASA_V0 testing



Testing parameters:

- GEMs detector: 280V-310 V
- E_{drift} : $\leq 280 \text{ V/cm}$
- Operation gases: $Ar/CF_4/iC_4H_{10} 95/3/2$ (T2K)
- Radioactive source: ⁵⁵Fe@ 1mCi

Low power ASIC chip- Baseline of the noise

Baseline of the noise without detector connecting

Baseline of the noise with TPC detector connecting @ V_{GEM}=0V@E_{drift}=0V/cm

Baseline of the noise with TPC detector connecting @ V_{GEM} =310V@E_{drift}=290V/cm



Low power ASIC chip- WASA_V0 testing



16 channels output waveform

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Low power ASIC chip- preliminary results

Spectrum of Fe-55 2000 ⁵⁵Fe testing: Event number = 23063Successfully Mean =304.52I SB commissioned and 1500 Sigma =34.06LSB collected signals using FWHM =26.34% DAQ Count 1000 Next steps: Using collimator for the 500 radioactive source and taking data from 0 more channels 0 200 400 600 800 and new DAQ to need Amplitude (LSB) (NO funding support)

- dE/dx study used TPC detector using 266nm UV laser
- ⁵⁵Fe and UV laser's energy spectrum and gain measured
- Pseudo-tracks with 220 layers and dE/dx can reach to $3.36 \pm 0.26\%$ of dE/dx by Pad size (1mm imes 6mm)
- Successfully testing and collected signals using the new electronics with the lower power consumption chips

Thanks

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2